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March 2013

FSA2000

Auto-Selecting HS-USB Switch with Cap-Free Headphone Audio Amplifier

Features

Switch Type	USB + Headphone Amplifier		
Switch Mechanism	Auto (USB with V _{BUS})		
USB Detection	YES		
USB	USB 2.0 High Speed &		
036	Full-Speed Compliant		
Audio Amplifier	Class AB		
Amplifier Output Power	40mW_{RMS} (32 Ω)		
Amplifier Gain	0dB		
THD+N	0.1%		
SNR	-90dB		
PSRR	-95dB		
Vcc	2.7 to 4.3V		
I _{CC (Audio)}	3mA		
I _{CC(USB)}	6μΑ		
Package	16- Lead UMLP 1.80 x 2.60 x		
1 ackaye	0.55mm, 0.40mm pitch		
Ordering Information FSA2000U			

Description

The FSA2000 is a low-cost integrated HS-USB and audio switch that incorporates an audio headphone amplifier. This solution eliminates many of the discrete parts currently used in stereo headset applications. It provides stereo headphone drivers designed to operate with a ground-centered output signal. This allows for the removal of large and expensive DC blocking capacitors. The headphone drivers are capable of driving up to $40 \text{mW}_{\text{RMS}}$ per channel.

Related Resources

- FSA2000 Demonstration Board
- FSA2000 Evaluation Board
- FDB323 FSA2000 Demonstration Board User Guide
- FEB322 FSA2000 Evaluation Board User Guide
- AN-8032 Demonstration Board Quick-Start Guide
- AN-8031 Utilizing the FSA2000 MUTE Function to Reduce Audio "Click" and "Pop"
- For samples, questions, or board requests; please contact: <u>Analog.Switch@fairchildsemi.com</u>.

Applications

- MP3 Portable Media Players
- Cellular Phones, Smartphones

Typical Application

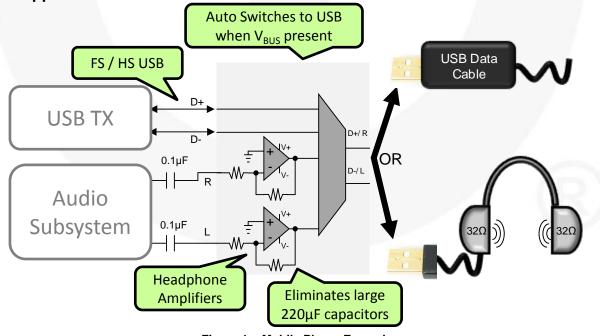


Figure 1. Mobile Phone Example

Pin Descriptions

Pin #	Name	Туре	Description
1	D+	I/O	USB D+ port from processor or transceiver
2	D-	I/O	USB D- port from processor or transceiver
3	R	Input	Right audio channel input
4	L	Input	Left audio channel input
5	V _{CC}	Audio Supply	Supply voltage for audio amplifiers, charge pump, and audio control; not required for USB path
6	MUTE	Input	Control pin intended to be used temporarily to quiet transients on the audio path upon transition of /SHDN. Ground if not being used.
7	/SHDN	Input	Shutdown Enable (Requires V _{CC} only)
8	GND	GND	IC ground
9	D-/L	I/O	Common USB/Audio Port; USB D- data to connector or left audio channel output
10	D+/R	I/O	Common USB/Audio Port; USB D+ data to connector or right audio channel output
11	V _{BUS}	Input/Supply	USB input select pin and USB supply
12	V+	Node	Node for filtering internal positive amplifier rail; suggest 1µF to GND
13	V-	Input	Negative amplifier rail input; suggest 1µF to GND. Requires connection to CPO.
14	СРО	Output	Charge pump output used to drive V-, suggest 2.2 µF to GND for filtering.
15	СМ	I/O	Charge pump negative flying capacitor pin; connect to CP via storage capacitor, typically 1µF.
16	СР	I/O	Charge pump positive flying capacitor pin; connect to CM via storage capacitor ,typically 1µF.

Pin Configuration

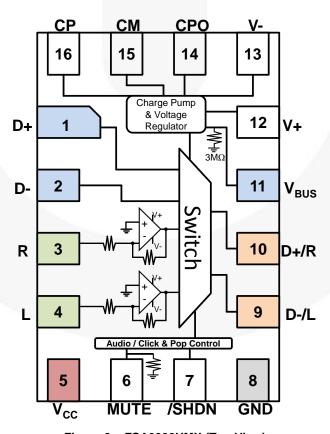


Figure 2. FSA2000UMX (Top View)

Functional Diagram

Functional Mode	Power Down	Audio Power Down	Transient Suppression	Audio Mode	USB Mode
V _{BUS}	LOW	LOW	LOW	LOW	HIGH
V _{cc}	LOW	HIGH	HIGH	HIGH	X ⁽¹⁾
/SHDN	X ⁽¹⁾	LOW	HIGH	HIGH	X ⁽¹⁾
MUTE	X ⁽¹⁾	X ⁽¹⁾	HIGH	LOW	X ⁽¹⁾
Charge Pump	OFF	OFF	ON	ON	OFF
R/L Amplifiers	OFF	OFF	OFF	ON	OFF
D+/R, D-/L	HI-Z	HI-Z	D+/R, D-/L=0V	R/L	D+/D-
Figure 3 Label	Α	В	С	D	Е

Notes:

1. The (X) indicates "Don't Care" state.

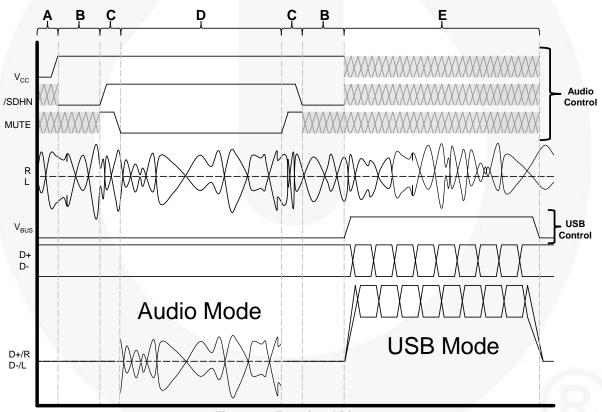
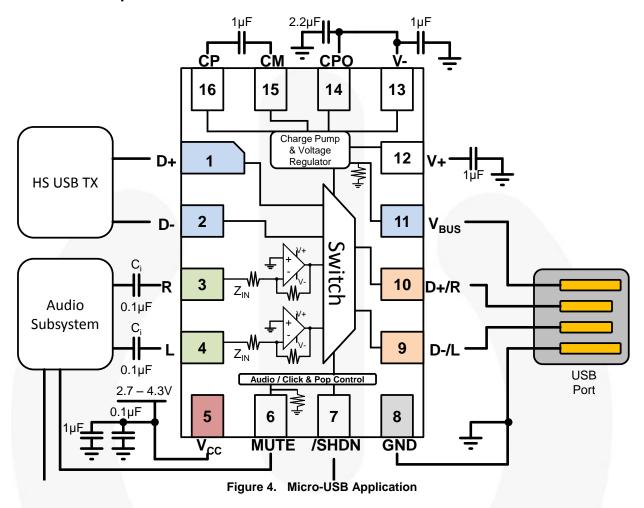


Figure 3. Functional Diagram

- Audio Power Down –An active-LOW shutdown pin (/SHDN) allows the amplifiers to be placed in low-power (or shutdown) mode to conserve battery power. While the FSA2000 is in shutdown mode, USB data transfers are allowed whenever a USB cable is connected to a host (V_{BUS} is HIGH). The audio amplifiers are enabled and connected to the common port when /SHDN is HIGH and V_{BUS} is LOW.
- Transient Suppression The FSA2000 audio amplifier has a soft turn-on feature that suppresses click and pop on the audio path when the path is selected. In addition to the soft turn-on feature of the amplifier, the MUTE pin mutes the audio path when asserted HIGH. The mute functionality also has an internal pull-down that disables mute if the MUTE pin is floated. The MUTE pin allows control of the mute functionality by the application. Please refer to application note AN-8031, describing the recommended timing and control of MUTE for optimal performance.

Functional Description



Application Guidelines

- Device Placement Minimize to USB port & USB TX.
- PIN 1, 2, 9, 10 Minimize and match trace lengths for USB compliance.
- PIN 3, 4 Suggest 0.1µFcapacitor as close to the device as possible for DC-blocking and setting low-frequency response of audio amplifier. The input capacitors combine with the input impedance of the amplifiers to form a high-pass filter. Equation 1 can be used to calculate the -3dB cut-off frequency of the high-pass filter for the given input capacitor value and the FSA2000 input impedance.

$$f_{-3dB} = \frac{1}{2\pi \cdot Z_{IN}C_i} \tag{1}$$

$$17.7Hz = \frac{1}{2\pi(90k\Omega)(0.1\mu F)}$$
 (2)

It is desirable to be below the 20Hz audio range.
 Users have flexibility to adjust capacitor for audio

performance in the system design. Equation 2 shows the cut-off frequency of the recommended guidelines.

- PIN 5 Use standard decoupling devices, 0.1μF & 1μF capacitors; as close to the device as possible.
- PIN 8 Minimize ground trace length between headphone connector and device; minimize ground path resistance.
- PIN 12 Suggested 0.1µFcapacitor to GND for filtering; as close to the device as possible.
- PIN13, 14 Use low-ESR (equivalent series resistance) ceramic capacitors for lowest charge pump impedance, which provides maximum output power of the audio amplifiers. Recommended to place the components as close as possible to the device.
- PIN15, 16 The charge pump has been optimized for low-ESR ceramic capacitors for the flying capacitor between CP and CM, along with the output capacitors on V+, CPO, and V-. Optimized values for these capacitors are in Figure 4.

Detailed Description

USB Compliance

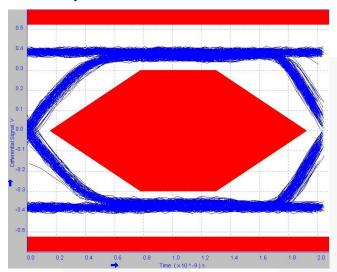


Figure 5. High-Speed USB 2.0 Eye Compliance (5.5V)

Transient Suppression

A common issue with headphone amplifiers is audible noises through the headset when the amplifier is powering up or down. Sharp transients often occur on the audio outputs during this transition that cause audible "click and pop." The FSA2000 prevents these transients during power-up by muting the outputs until the internal charge pumps are stable. This ensures that any transients caused by the charge pump are not propagated to the outputs. In cases where the application needs a longer startup time for mute, the FSA2000 has a MUTE pin that allows application control

over the behavior of the amplifier during startup and power down. The MUTE pin forces the audio outputs into a known and controlled state so that any transients of the amplifier are not propagated to the headphones as clicks and pops. Figure 6 shows the correct timing of the MUTE pin in relation to the /SHDN pin for optimal click and pop performance.

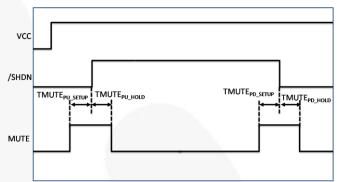


Figure 6. Power-Up and Power-Down Timing

Table 1. Recommended MUTE Timing

Parameter	Description	Suggested Timing			
TMUTE _{PU_SETUP}	MUTE setup time to /SHDN rising edge	≥500ns			
TMUTE _{PU_HOLD}	MUTE hold time to /SHDN rising edge	~500ns			
TMUTE _{PD_SETUP}	MUTE setup time to /SHDN falling edge	≥500ns			
TMUTE _{PD_HOLD}	MUTE hold time to /SHDN falling edge	~500ns			

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol		Parameter				Unit
\/	Cupply Voltage	Audio Mode		-0.3	+4.5	V
V _{cc}	Supply Voltage	USB Mode		-0.3	+6.0	V
V_{BUS}	Supply Voltage			-0.3	+6.0	V
V_{CNTRL}	Control Pin Voltage - /SF	IDN, MUTE		-0.3	+6.0	V
V _{SWUSB}	USB I/O			V _{BUS} - 6.0	V _{BUS} + 0.3	V
V _{SWAUDIO}	Audio I/O			V _{CC} - 6.0	V _{CC} + 0.3	V
I _{SW}	Switch I/O Current (Cont	inuous)			30	mA
I _{PEAK}	Peak Switch I/O Current	(Pulsed, 1ms Duration, <10% Duty Cycle)	1/4		50	mA
T_J	Junction Temperature				+150	°C
T _{STG}	Storage Temperature Ra	ange		-65	+150	°C
TL	Lead Temperature (Sold	ering, 10 seconds)			+240	°C
	IEC 61000-4-2 System	USB Connector pins (D+/R, D-/L, V _{BUS})	Air Gap	15		
			D+/R, D-/L	4		
ESD	JEDEC JESD22-A114, H	All Other Pins	2	3	kV	
	1		V _{BUS}	1		
	JEDEC JESD22-C101, Charged Device Model All Pins			2		

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding these ratings or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Тур.	Max.	Unit
V _{BUS}	USB Supply Voltage	4.0	5.0	5.5	V
Vcc	Supply Voltage	2.7	3.3	4.5	V
V _{CNTRL}	Control Voltage - /SHDN, MUTE	0		V _{cc}	V
V_{SWUSB}	D+/L, D-/R, D+, D- Input Range	0		V _{BUS}	V
V_{SWAUDIO}	L,R Audio Input Range	-2.5		V _{cc}	V
V_{SWING}	L,R Audio Input Amplitude			5	V_{P-P}
T_A	Temperature Range	-40	+25	+85	°C
Z_{LOAD}	Z _{LOAD} Headset Load Impedance		32		Ω
Θ_{JA}	Package Thermal Resistance, JEDEC Standard Multi-Layer Boards, Still Air		40		°C/W

DC Electrical Characteristics

 $T_A = 25^{\circ}\text{C}$, $V_{CC} = 3.0\text{V}$, audio inputs at -6dBV and AC coupled with $0.1\mu\text{F}$, audio outputs DC coupled into 32Ω loads referenced to 1kHz, unless otherwise noted.

Cumbal	Davamatar	V 00	c (V) Conditions		- 40°C to -	+85°C	l lmis
Symbol	Parameter	V _{CC} (V)			Тур.	Max.	Unit
Common P	ins	1					•
V _{IH}	/SHDN, MUTE, Control Input Voltage HIGH	2.7 to 4.5		1.65			V
V _{IL}	Control Input Voltage LOW	2.7 to 4.5				0.5	
1	/SHDN, MUTE, Input HIGH	4.5	V _{CNTRL} = 3.6V	-1		10	
I _{IN}	Current	4.5	$V_{CNTRL} = 0V$	-1		1	μA
I _{OFF}	Power Off Leakage Current	$V_{CC} = V_{BUS} = 0$	Common Port (D+/R, D-/L) V _{SW} = 0V, 5.5V			10	μA
I _{NO(0FF)}	Off-Leakage Current of Port D+, D-	3.6	D+/R, D-/L = 0.3V, V _{CC} - 0.3V, D+, D- = 0.3V, V _{CC} - 0.3V or Floating, /SHDN=0V, V _{BUS} =0v, MUTE=0V, R/L=0V	-50	1	50	nA
I _{NC(0N)}	On-Leakage Current of Port D+/R or D-/L	3.6	$\begin{array}{l} \text{D+/R, D-/L} = 0.3\text{V, V}_{\text{CC}} - 0.3\text{V} \\ \text{D+, D-} = \text{Floating} \\ \text{V}_{\text{BUS}} = 5.5\text{V, /SHDN=0V,} \\ \text{MUTE=0V, R/L=0V} \end{array}$	-50	1	50	nA
R_{PD}	V _{BUS} , MUTE, Internal Pull-Down Resistor				3.5		МΩ
USB Switch	n Path					10	
	USB Analog Signal Range			0		3.6	V
R _{ONUSB}	HS Switch On Resistance ⁽²⁾	V _{BUS} =5	$V_{D+/D}$ - = 0V, 0.4V, I_{ON} = -8mA		4.0	6.5	Ω
ΔR_{ONUSB}	HS Delta R _{ON} ^(2, 3)	V _{BUS} =5	$V_{D+/D-} = 0V$, $I_{ON} = -8mA$		0.4		Ω
Audio Amp	lifier Path						
Z _{IN}	Audio Amp Input Impedance ⁽⁴⁾	3.0 to 4.5			90		kΩ
Power Supp	oly				•		
I _{CC(Audio)}	Quiescent Supply Current (Audio Mode)	4.5	I _{OUT} = 0, /SHDN = V _{CC} , MUTE=0V, D+/D-=0V	1	3	5	mA
I _{CC(/SHDN)}	Quiescent Supply Current (V _{CC}) in Shutdown Mode	4.5	I _{OUT} = 0, /SHDN = 0V, MUTE=0V, D+/D-=0V		1	5	μА
$I_{CC(USB)}$	Quiescent Supply Current (USB Mode)	V _{BUS} =5.5	I _{OUT} =0, MUTE=0V, /SHDN=V _{BUS} , L/R=0V		6	10	μA

Notes:

- On resistance is determined by the voltage drop between the D+/D- and D+/R,D-/L pins at the indicated current through the switch.
- $\Delta R_{ON} = R_{ON_max} R_{ON_min} \ \text{measured at identical V_{CC}, temperature, and voltage.}$ Guaranteed by characterization, but not production tested.

AC Electrical Characteristics

 T_A = 25°C, V_{CC} = 3.0V, audio inputs at -6dBV and AC coupled with 0.1 μ F, audio outputs DC coupled into 32 Ω loads referenced to 1kHz, unless otherwise noted.

Symbol	Parameter	V (\/\)	Conditions	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			1114
Symbol	Parameter	V _{CC} (V)	Conditions	Min.	Тур.	Max.	Unit
Audio Amp	lifier Path					•	•
tonaudio	Turn-On Time /SHDN to Output	3.0 to 4.5	$V_{D+/R, D-/L} = 1.0V; C_L = 0pF,$			1	ms
t _{OFFAUDIO}	Turn-Off Time /SHDN to Output	3.0 to 4.5	$V_{D+/R, D-/L} = 1.0V; C_L = 0pF$			100	μs
t _{MUTE_ON}	MUTE Turn-On Time	3.0 to 4.5			1		μs
t _{MUTE_OFF}	MUTE Turn-Off Time	3.0 to 4.5			1		μs
		2.7			25		
P_{out}	Output Power ⁽⁵⁾	3.3	THD_N=1%, V _{L,R} In Phase, R _{LOAD} =32Ω, 1KHz		35		mW _{rms}
		4.5	TILOAD-0232, TIVI2		40		
Vos	Output Offset Voltage		Inputs Grounded		5		mV
A _V	Amplifier Gain		Input = -26dBV at 1kHz, R _L =16Ω		0		dB
A _{MATCH}	Gain Matching of L & R Channels ⁽⁵⁾		Input = -26dBV, 20Hz to 20kHz			0.5	dB
f _R	Frequency Response ⁽⁵⁾		20Hz to 20kHz referenced to 1kHz	-1.5		1.5	dB
THD+N	Distortion ⁽⁵⁾		f=1KHz, V_{sw} =50mVrms, R_L =64 Ω		0.1		%
SNR	Signal to Noise Ratio ⁽⁵⁾		A Weighted		-90		dB
XTLK _{sprk}	Crosstalk between L & R Channel ⁽⁵⁾		Input=-26bBV		-60		dB
USB Switch	n Path						
t _{PDUSB}	USB Switch Propagation Delay ⁽⁵⁾	4.0 to 5.5	$R_L = 50\Omega$; $C_L = 0pF$		0.25		ns
t _{ONUSB}	Turn-On Time V _{BUS} to Output	4.0 to 5.5	$V_{D+/R, D-/L} = 1.0V; R_L = 32\Omega;$ $C_L = 0pF, /SHDN, V_{CC} = 0$			5.5	μs
t _{OFFUSB}	Turn-Off Time V _{BUS} to Output	4.0 to 5.5	$V_{D+/R, D-/L} = 1.0V; R_L = 32\Omega;$ $C_L = 0pF, /SHDN, V_{CC} = 0$			2	μs
BW	-3db Bandwidth – USB	4.0 to 5.5	R _L =50Ω, C _L =0pF, Signal 0dBm		720		MHz
Power Supp	ply			A			
t _{SUPPLY}	Power-Up Stabilization Time		V+, V- within 90% of Final Value			1	ms
PSRR _{SPKR}	Power Supply Noise Rejection at Common Output ⁽⁵⁾		217Hz 12% Duty Cycle Square Wave 2.7V to 3.2V at V _{CC} Output (D+/R) in V _{ms} as Single Wideband Noise Measurement within 20Hz – 20kHz, A Weighted		-95		dB

Note:

5. Guaranteed by characterization; not production tested.

USB High-Speed-Related AC Electrical Characteristics

 $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	V (\(\)	Conditions	T _A = - 40°C to +85°C			Unit
Symbol	Parameter	V _{BUS} (V)	Conditions	Min.	Тур.	Max.	Unit
t _{SK(P)}	Skew of Opposite Transitions of the Same Output ⁽⁶⁾	4.0 to 5.5	$t_R = t_F = 750 ps (10-90\%)$ at 240MHz $C_L = 0 pF$, $R_L = 50 \Omega$		35		ps
t _J	Total Jitter ⁽⁶⁾	4.0 to 5.5	$R_L = 50\Omega$, $C_L = 50pF$, $t_R = t_F = 500ps$ (10-90%) at 480Mbps (PRBS = $2^{15} - 1$)		130		ps

Note:

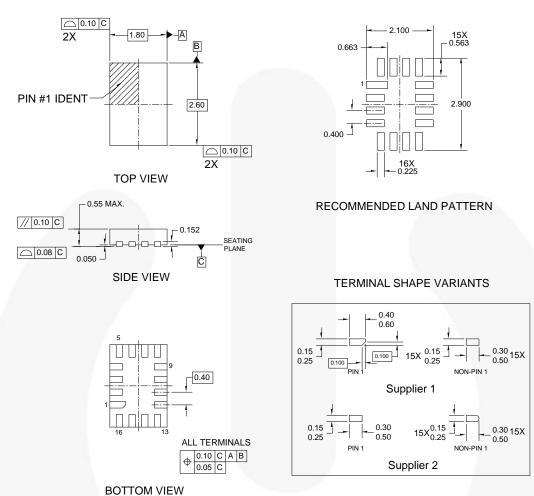
6. Guaranteed by characterization; not production tested.

Capacitance

 $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	V N (V)	Conditions		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		
Syllibol	raiailleter	V _{CC} /V _{BUS} (V)	Conditions	Min.	Тур.	Max.	Unit
C _{IN}	Control Pin Input Capacitance (/SHDN, MUTE)	V _{CC} = 3.0, 4.5	V _{Bias} = 0.05V		2.8		pF
C _{ON_USB}	D+, D- (Source Port) On Capacitance	V _{BUS} =5.0	$V_{Bias} = 0.2V$, $f = 1MHz$, $f=240MHz$		8.8		pF
C _{OFF_USB}	D+, D- (Source Port) Off Capacitance	V _{BUS} =5.0	f = 1MHz		2.8		pF

Physical Dimensions



NOTES:

- A. THIS PACKAGE IS NOT CURRENTLY REGISTERED WITH ANY STANDARDS COMMITTEE
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994
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Figure 7. 16-Pin Ultrathin Molded Leadless Package (UMLP)

Order Number	Operating Temperature Range	Package Description	Packing Method
FSA2000UMX	-40 to 85°C	16-Terminal Ultrathin Molded Leadless Package (UMLP)	Tape & Reel

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Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Product Status	Definition
Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
	Formative / In Design First Production Full Production

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